

UNITED STATES PATENT AND TRADEMARK OFFICE

BEFORE THE PATENT TRIAL AND APPEAL BOARD

Taiwan Semiconductor Manufacturing Company Ltd. and Apple Inc.,

Petitioners,

v.

Marlin Semiconductor Ltd.,

Patent Owner.

Patent No. 9,147,747

Filing Date: May 2, 2013

Issue Date: September 29, 2015

Title: Semiconductor Structure with Hard Mask Disposed
on the Gate Structure

Case No. IPR2025-00865

**PETITIONERS' REQUEST FOR REFUND OF
POST-INSTITUTION FEES**

On April 17, 2025, Taiwan Semiconductor Manufacturing Co., Ltd. and Apple Inc. (“Petitioners”) filed a petition for *inter partes* review of U.S. Patent No. 9,147,747 with the Patent Trial and Appeal Board. In accordance with the fee schedule specified in 37 C.F.R. § 42.15(a), Petitioners deposited an electronic payment at the time of filing of the petition, including \$23,750 for fees associated with Petitioner’s request for review and a further \$28,125 for post-institution fees. On September 3, 2025, the Board entered a Decision Denying of *Inter Partes Review*, and on November 5, 2025 the Board entered an Order denying requests for Director Review. Therefore, Petitioners request a refund in the amount of \$28,125 to be paid to Deposit Account Number 50-2613 for the post-institution fees, which are no longer necessary.

Respectfully submitted,

Dated: March 16, 2026

By: /Naveen Modi/
Naveen Modi (Reg. No. 46,224)
Paul Hastings LLP

Counsel for Petitioner TSMC

CERTIFICATE OF SERVICE

I hereby certify that on March 16, 2026, a copy of the foregoing Petitioners' Request for Refund of Post-Institution Fees was served by e-mail upon the following:

William A. Meunier (Reg. No. 41,193)

WAMeunier@mintz.com

Adam S. Rizk (Reg. No. 66,867)

ARizk@mintz.com

Michael T. Renaud (Reg. No. 44,299)

MTRenaud@mintz.com

Reza Dokhanchy (Reg. No. 62,795)

RDokhanchy@mintz.com

Tawfik Goma (Reg. No. 67,416)

TAGoma@mintz.com

Mintz-Marlin-IPRs@mintz.com

Dated: March 16, 2026

By: /Naveen Modi/

Naveen Modi (Reg. No. 46,224)

Paul Hastings LLP

Counsel for Petitioner TSMC